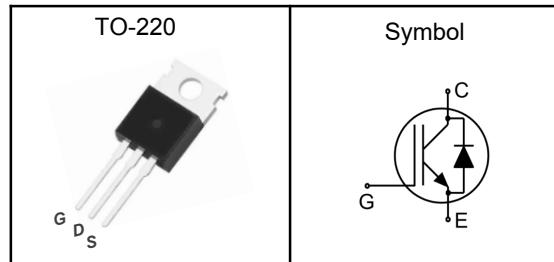


## 600V/20A Field Stop Trench IGBT

### Features

- Trench FS II Technology
- Very low VCE(sat)
- High speed switching
- ROHS Compliant

### Pin Description



### Applications

- Inverter welding machine
- Motor drives
- UPS

$V_{CES}$	600	V
$V_{CE(sat)-Typ}$	1.7	V
$I_c$	20	A

### Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$ , Unless Otherwise Noted)

Parameter		Symbol	Rating	Units
Collector-Emitter Voltage		$V_{CES}$	600	V
Gate- Emitter Voltage		$V_{GES}$	$\pm 30$	V
Collector Current <sup>1</sup>	$T_c=25^\circ\text{C}$	$I_c$	40	A
Collector Current <sup>1</sup>	$T_c=100^\circ\text{C}$	$I_c$	20	A
Pulsed Collector Current <sup>2</sup>		$I_{CM}$	60	A
Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	$I_F$	40	A
Diode Continuous Forward Current	$T_c=100^\circ\text{C}$	$I_F$	20	A
Diode Pulsed Forward Current		$I_{FM}$	60	A
Power Dissipation	$T_c=25^\circ\text{C}$	$P_D$	135	W
Power Dissipation	$T_c=100^\circ\text{C}$	$P_D$	54	W
Storage Temperature Range		$T_{STG}$	-55 to 150	°C
Operating Junction Temperature Range		$T_J$	-55 to 150	°C

### Thermal Characteristics

Parameter		Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient		$R_{\theta JA}$	---	62	°C/W
Thermal Resistance Junction to case for IGBT		$R_{\theta JC}$	---	0.92	°C/W
Thermal Resistance Junction to case for Diode		$R_{\theta JCD}$	---	1.92	°C/W

## 600V/20A Field Stop Trench IGBT

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-Emitter Breakdown Voltage	$V_{(\text{BR})\text{CES}}$	$V_{\text{GE}}=0\text{V}, I_D=1\text{mA}$	600	---	---	V
Collector-Emitter Saturation Voltage	$V_{\text{CE}(\text{sat})}$	$V_{\text{GE}}=15\text{V}, I_C=15\text{A}, T_J=25^\circ\text{C}$	---	1.7	1.9	V
		$V_{\text{GE}}=15\text{V}, I_C=15\text{A}, T_J=100^\circ\text{C}$	---	1.9	---	V
Gate Threshold Voltage	$V_{\text{GE}(\text{th})}$	$V_{\text{CE}}=V_{\text{GE}}, I_C=1\text{mA}$	4	---	6	V
Collector-Emitter Leakage Current	$I_{\text{CES}}$	$V_{\text{CE}}=600\text{V}, V_{\text{GE}}=0\text{V}, T_J=25^\circ\text{C}$	---	---	0.04	mA
		$V_{\text{CE}}=600\text{V}, V_{\text{GE}}=0\text{V}, T_J=150^\circ\text{C}$	---	---	1	mA
Gate to Emitter Leakage Current	$I_{\text{GES}}$	$V_{\text{GE}}=\pm 30\text{V}, V_{\text{CE}}=0\text{V}$	---	---	$\pm 100$	nA
Total Gate Charge	$Q_g$	$V_{\text{CC}}=480\text{V}, V_{\text{GE}}=15\text{V}, I_C=20\text{A}$	---	97	---	nC
Gate to Emitter Charge	$Q_{\text{ge}}$		---	17	---	nC
Gate to Collector Charge	$Q_{\text{gc}}$		---	35	---	nC
Turn-On Delay Time	$t_{\text{d}(\text{ON})}$	$V_{\text{CE}}=400\text{V}, V_{\text{GE}}=0/15\text{V}, R_G=25\Omega, I_C=10\text{A}, T_J=25^\circ\text{C}$ Inductive Load	---	18	---	ns
Rise Time	$t_r$		---	16	---	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		---	160	---	
Fall Time	$t_f$		---	15	---	
Turn-On Switching Loss	$E_{\text{on}}$		---	0.45	---	mJ
Turn-Off Switching Loss	$E_{\text{off}}$		---	0.16	---	
Total Switching Loss	$E_{\text{ts}}$		---	0.58	---	
Input Capacitance	$C_{\text{ies}}$	$V_{\text{CE}}=25\text{V}, V_{\text{GE}}=0\text{V}, f=1\text{MHz}$	---	2580	---	pF
Output Capacitance	$C_{\text{oes}}$		---	48	---	
Reverse Transfer Capacitance	$C_{\text{res}}$		---	26	---	

### Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode Forward Voltage	$V_F$	$V_{\text{GE}}=0\text{V}, I_F=20\text{A}, T_J=25^\circ\text{C}$	---	1.4	1.7	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_F=20\text{A}, V_{\text{CC}}=400\text{V}$ $dI/dt=200\text{A}/\mu\text{s}, T_J=25^\circ\text{C}$	---	182	---	nS
Reverse Recovery Charge	$Q_{\text{rr}}$		---	0.5	---	uC
Diode Peak Reverse Recovery Current	$I_{\text{rrm}}$	---	---	5.3	---	A

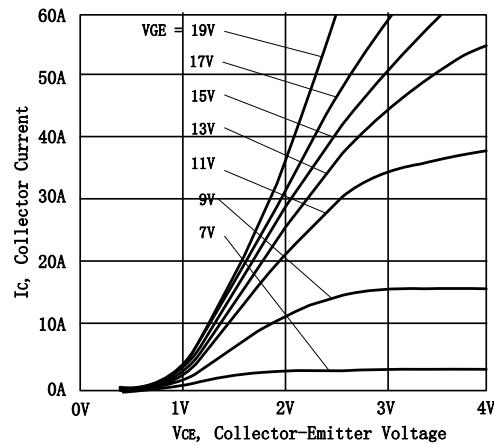
#### Note:

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$

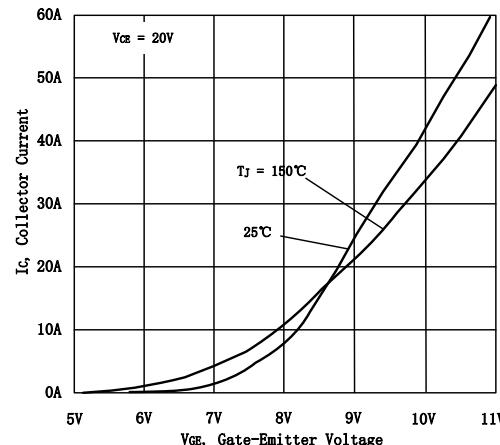
## 600V/20A Field Stop Trench IGBT

### Typical Characteristics

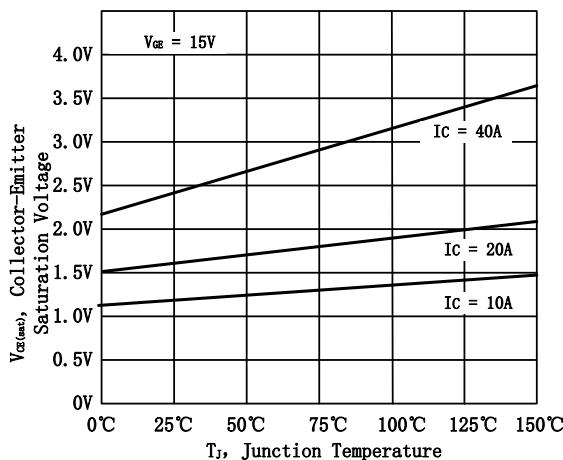
**Figure 1 Output Characteristics**



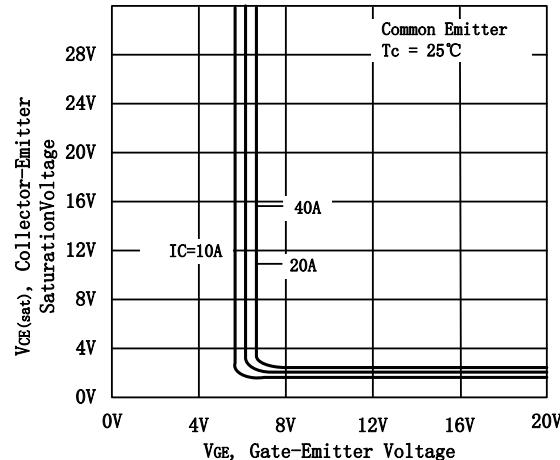
**Figure 2 Transfer Characteristics**



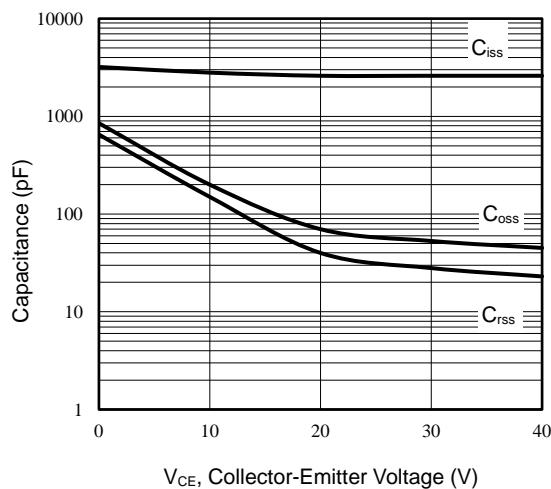
**Figure 3  $V_{ce(sat)}$  vs. Case Temperature**



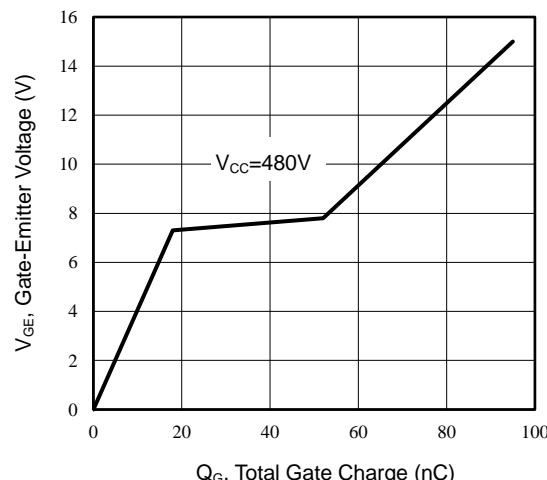
**Figure 4 Saturation Voltage vs. VGE**



**Figure 5 Capacitance Characteristics**

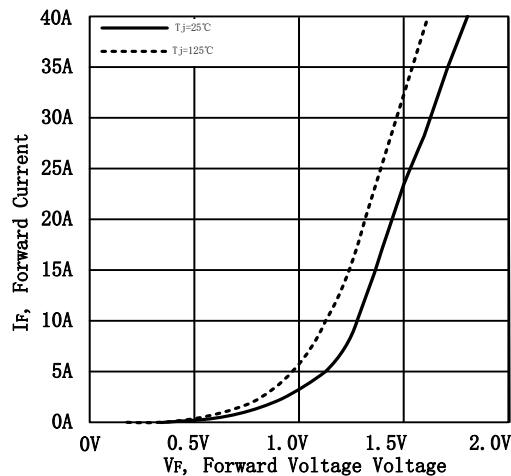


**Figure 6 Gate charge waveform**

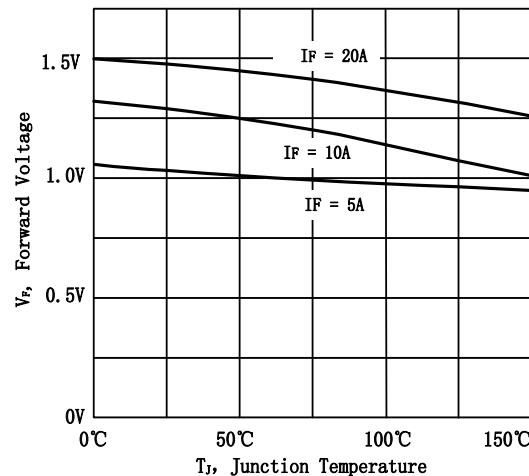


## 600V/20A Field Stop Trench IGBT

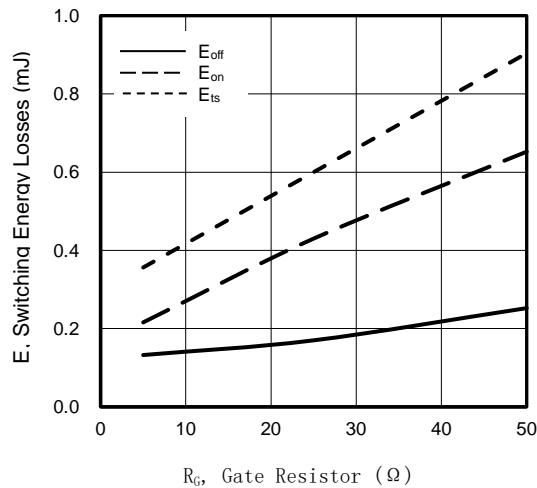
**Figure 7 Forward Characteristics**



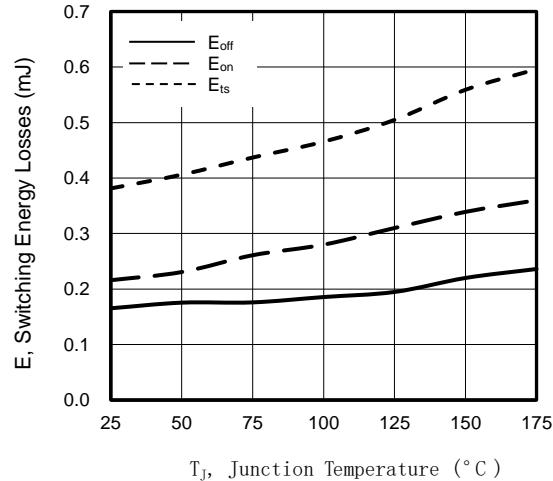
**Figure 8 V<sub>f</sub> vs. temperature**



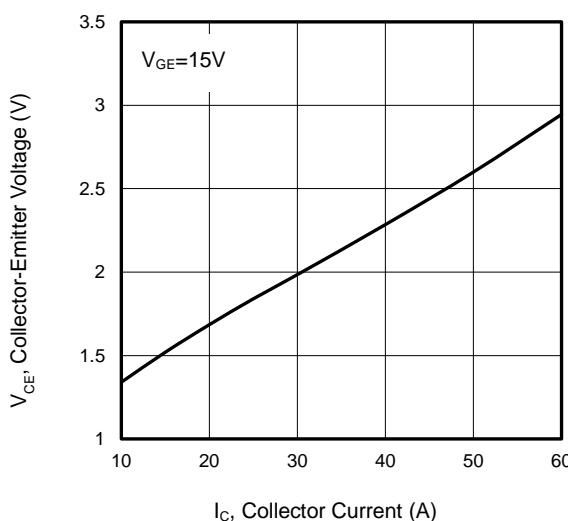
**Figure 9 Typical Switching Times as a Function of Gate Resistor**



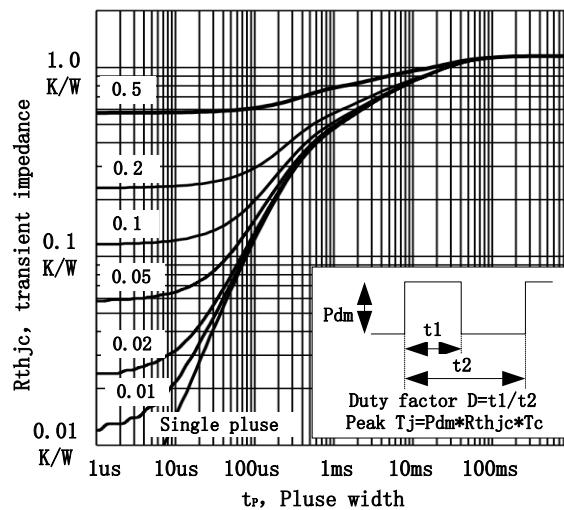
**Figure 10 Typical Switching Times as a Function of Junction Temperature**

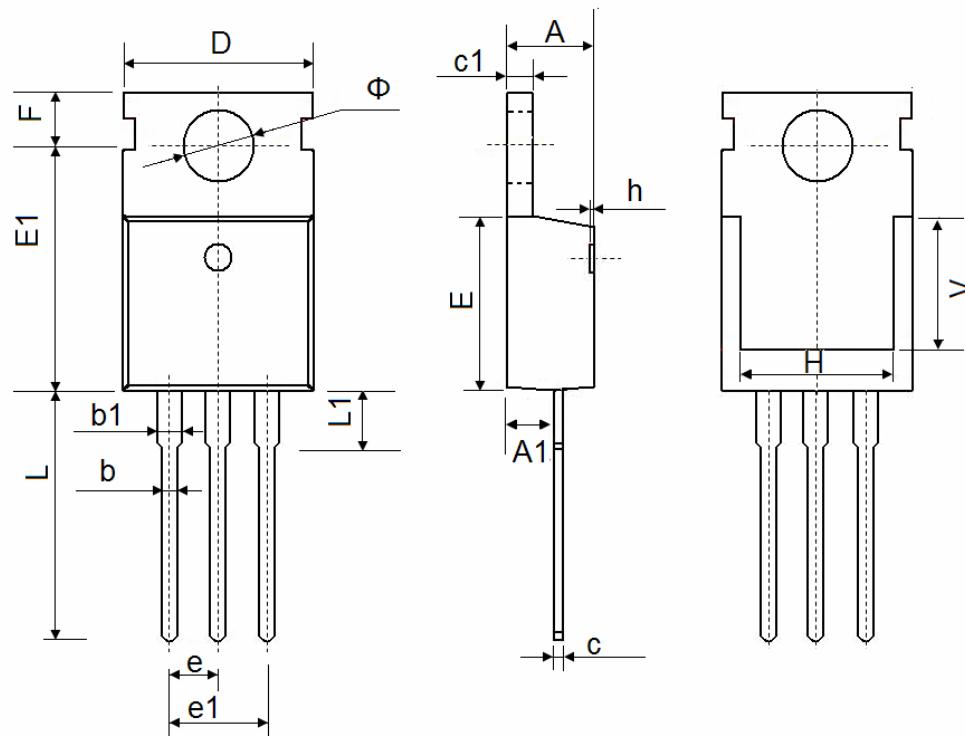


**Figure 11 Typical Collector-emitter Saturation Voltage as a function of Collector Current**



**Figure 12 Transient Thermal Impedance**



**600V/20A Field Stop Trench IGBT**
**TO-220 Package Outline Data**


Symbol	Dimensions In Millimeters	
	Min.	Max.
A	4.350	4.650
A1	2.250	2.550
b	0.710	0.910
b1	1.170	1.400
c	0.330	0.650
c1	1.200	1.400
D	9.910	10.250
E	8.9500	9.750
E1	12.650	12.950
e	2.540 TYP.	
e1	4.980	5.180
F	2.650	2.950
H	7.900	8.100
h	0.000	0.300
L	12.700	13.500
L1	2.850	3.250
V	7.500 REF.	
Φ	3.400	3.800